



TAOGLAS®



Datasheet

Part No:
SGGP254B

Description

GPS/GLONASS/GALILEO/BEIDOU Ceramic SMD Patch Antenna

Features:

SMD Mount Ceramic Patch Antenna

Coverage:

- B1I: 1561 MHz
- L1/E1: 1575.42 MHz
- G1: 1602 MHz

Dimension: 25 x 25 x 4mm

Includes Additional Solder Mask

RoHS & Reach Compliant

1.	Introduction	3
2.	Specification	4
3.	Mechanical Drawing	6
4.	Packaging	7
5.	Antenna Integration Guide	8
6.	Antenna Characteristics	15
7.	Radiation Patterns	19
8.	Solder Reflow Profile	23
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	Changelog	24

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1. Introduction



The SGGP254B is a compact ceramic GPS/GLONASS/GALILEO/BEIDOU passive patch antenna, measuring just 25mm x 25mm with a low-profile height of 4mm. Its small form factor makes it ideal for space-constrained applications such as compact telematics devices, vehicle tracking and fleet management systems, wearables, and navigation devices.

The antenna is optimized for a 50mm x 50mm ground plane, operating at 1575.42MHz, 1602MHz and 1561MHz with a peak gain of 2.4dBi gain, 2.57dBi gain and 0.78dBi gain. Designed for SMT mounting, the ceramic patch includes an additional solder mask to enhance durability and prevent cracking due to heat expansion during high-volume, cost-sensitive assembly processes.

Typical applications include:

- Vehicle Tracking and Fleet Management Systems
- Wearables
- Navigation Devices

The SSGP Series can be manufactured in a TS16949 first-tier automotive-approved facility and tested to AEC-Q200 certification if required. Further to this, full PPAP and IMDS documentation can be provided upon request. Please discuss your quality and reliability requirements with our team prior to ordering.

Taoglas also offers custom tuning services based on minimum order quantities, contact your regional Taoglas customer support team for further information.

2. Specification

GNSS Frequency Bands					
GPS	L1 1575.42 MHz	L2 1227.6 MHz	L5 1176.45 MHz		
	■	□	□		
GLONASS	G1 1602 MHz	G2 1248 MHz	G3 1207 MHz		
	■	□	□		
Galileo	E1 1575.24 MHz	E5a 1176.45 MHz	E5b 1201.5 MHz	E6 1278.75 MHz	
	■	□	□	□	
BeiDou	B1C 1575.42 MHz	B1I 1561 MHz	B2a 1176.45 MHz	B2b 1207.14 MHz	B3 1268.52 MHz
	■	■	□	□	□
L-Band	L-Band 1542 MHz				
	□				
QZSS (Regional)	L1 1575.42 MHz	L2C 1227.6 MHz	L5 1176.45 MHz	L6 1278.75e6	
	■	□	□	□	
IRNSS (Regional)	L5 1176.45 MHz				
	□				
SBAS	L1/E1/B1 1575.42 MHz	L5/B2a/E5a 1176.45 MHz	G1 1602 MHz	G2 1248 MHz	G3 1207 MHz
	■	□	■	□	□



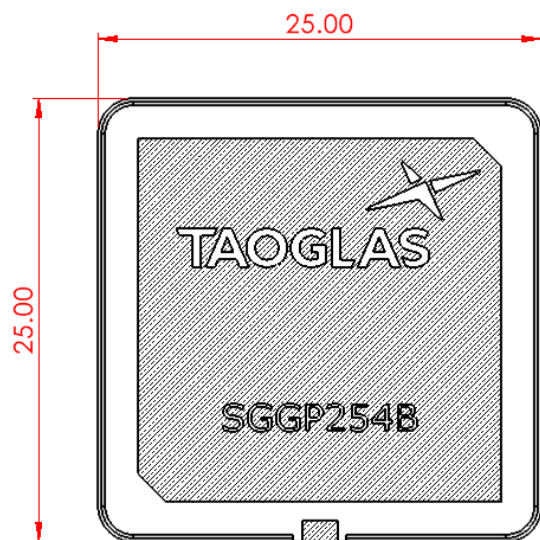
GNSS Bands and Constellations

GNSS Electrical			
Frequency (MHz)	B1I – 1561 MHz	L1 - 1575.42 MHz	G1 – 1602 MHz
	1559-1565	1565-1586	1596-1610
Efficiency (%)	39.52	57.24	51.48
Average Gain (dB)	-4.03	-2.42	-2.88
Peak Gain (dBi)	0.78	2.40	2.57
Polarization	RHCP		
Impedance	50 Ω		
*Tested on a 50x50mm Ground Plane			

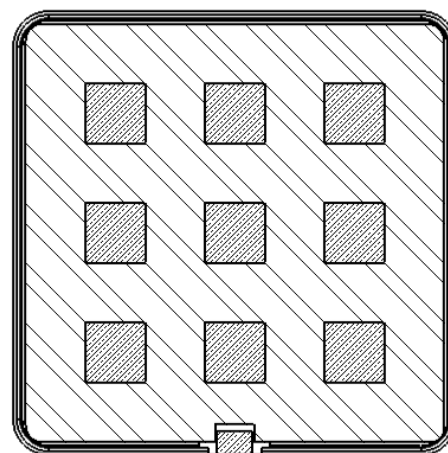
Mechanical	
Dimensions	25mm x 25mm x 4mm
Weight	10g \pm 3%
Material	Ceramic

Environmental	
Operation Temperature	-40°C to 105°C
Storage Temperature	-40°C to 105°C
Relative Humidity	Non-condensing 65°C 95% RH
Moisture Sensitivity	3 (168 hours)

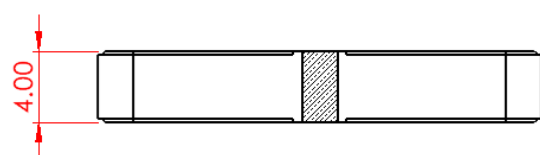
3. Mechanical Drawing



TOP



BOTTOM



SIDE

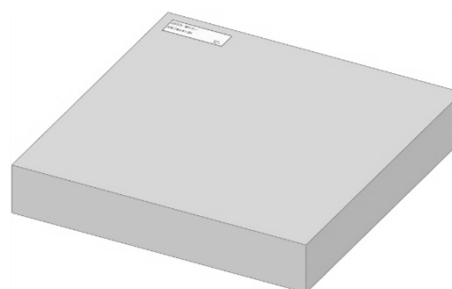


4. Packaging

200 pcs/ Reel/ Vacuum bag



200 pcs / Box
Box: 350x340x67mm
Weight: 2.63 ±3% Kg

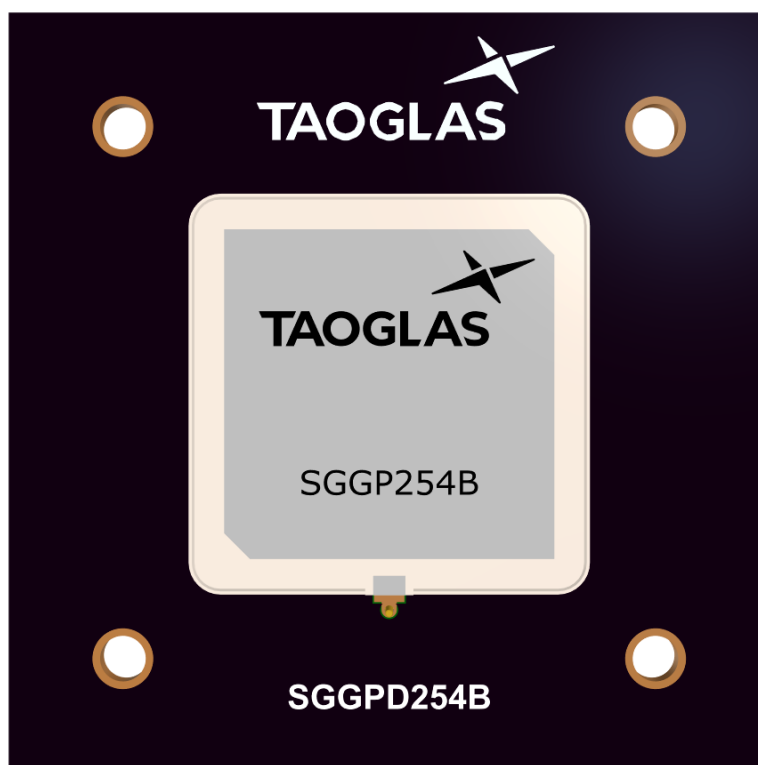


800 pcs / Carton
Carton: 370x370x300mm
Weight: 11.3 ±3% Kg



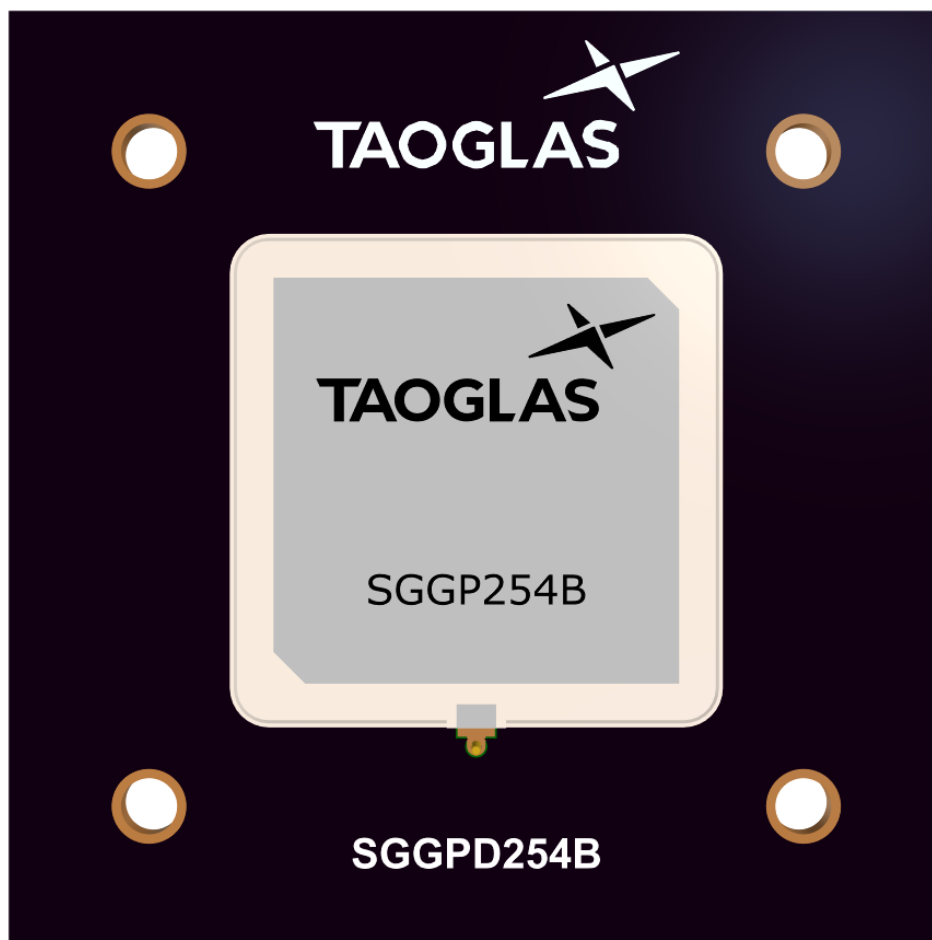
5. Antenna Integration Guide

The following is an example on how to integrate the SGGP254B into a design. This antenna has 10 pins, where one pin is used for the RF Feed. Taoglas recommends using a minimum of 50x50mm ground plane (PCB) to ensure optimal performance.



Top view of PCB reference design.

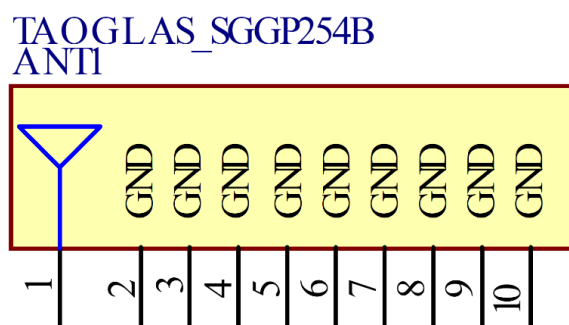
5.1 Schematic and Symbol Definition



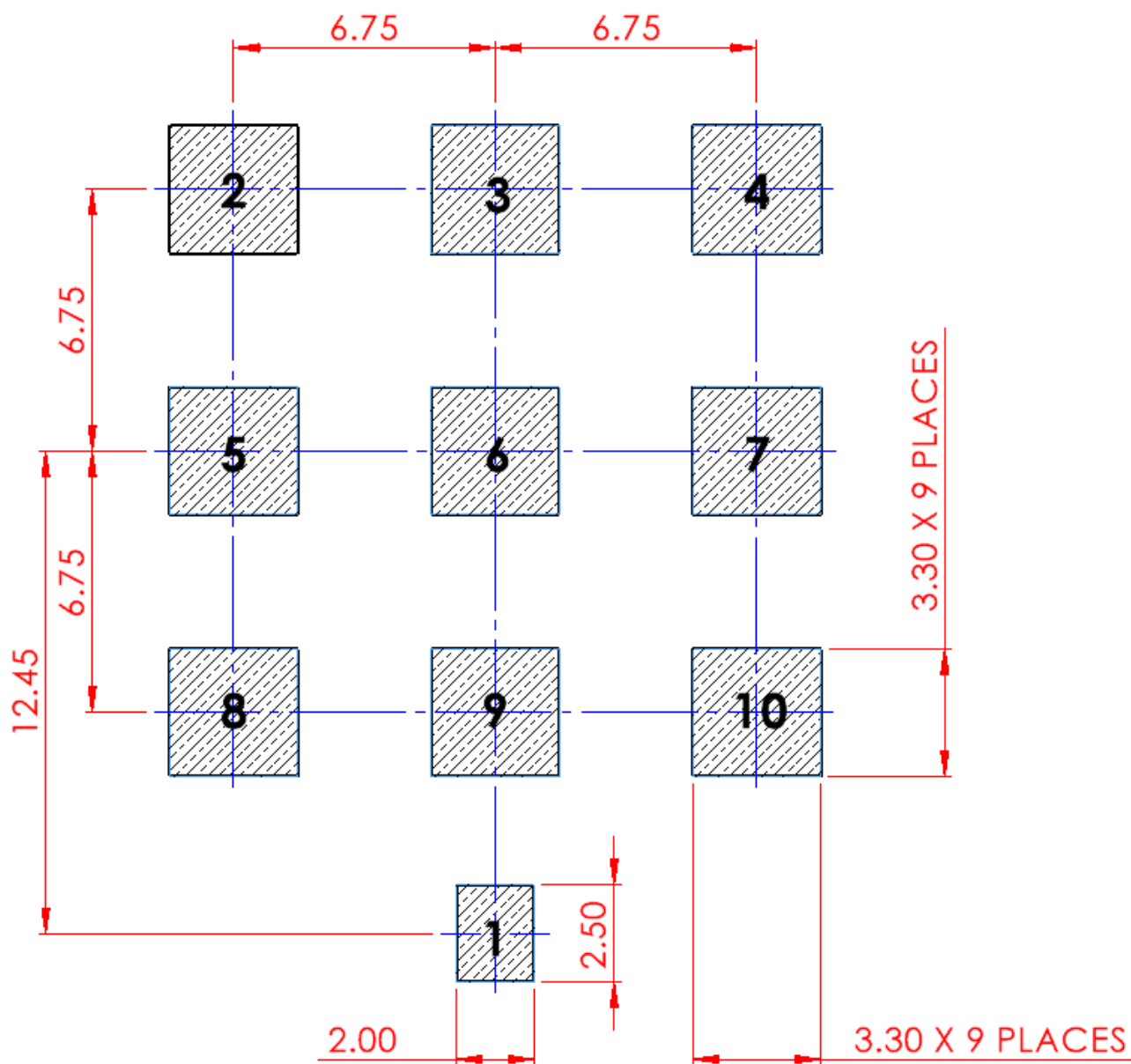
Above is a 3D model of the SGGP254B on a PCB reference design.

The circuit symbol for the SGGP254B is shown below. The antenna has 10 pins as indicated below.

Pin	Description
1	RF Feed
2-10	Ground

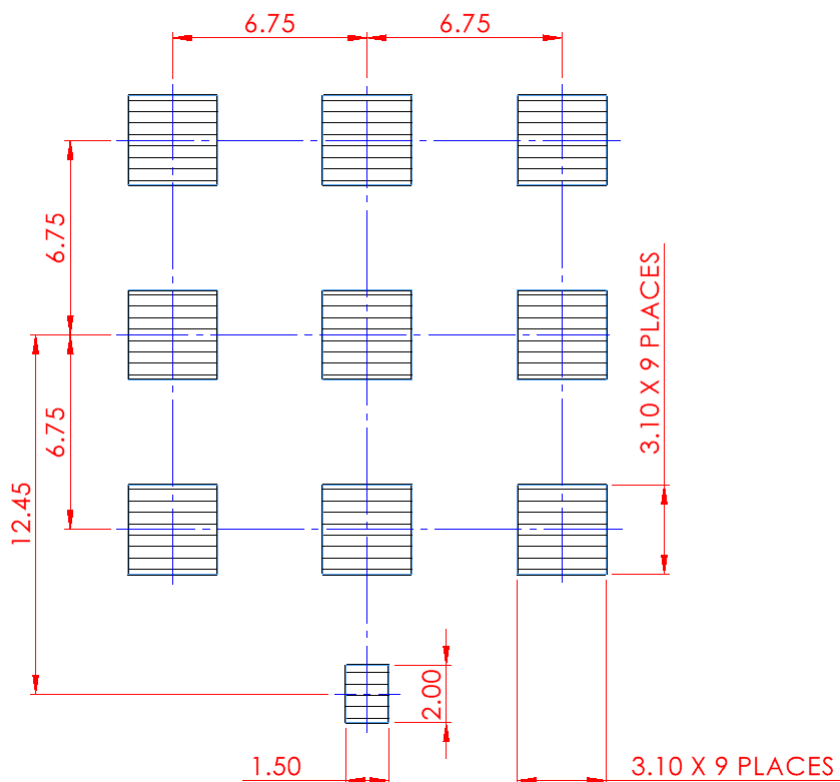


5.2 Antenna Footprint

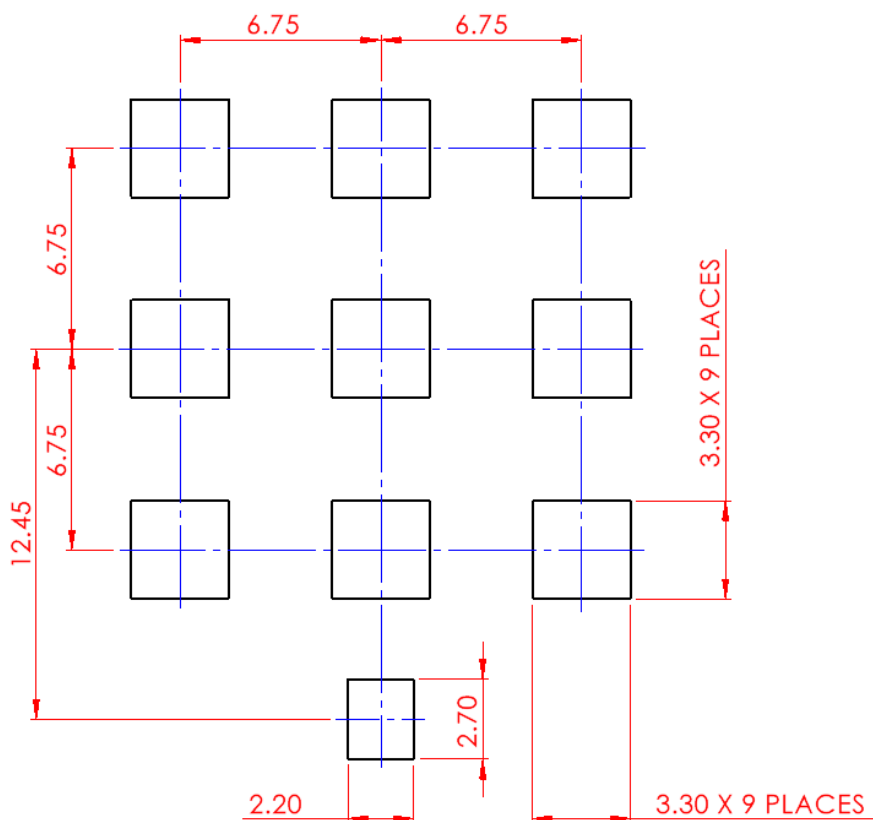


Pin	Description
1	RF Feed
2-10	Ground

5.3 Top Solder Paste



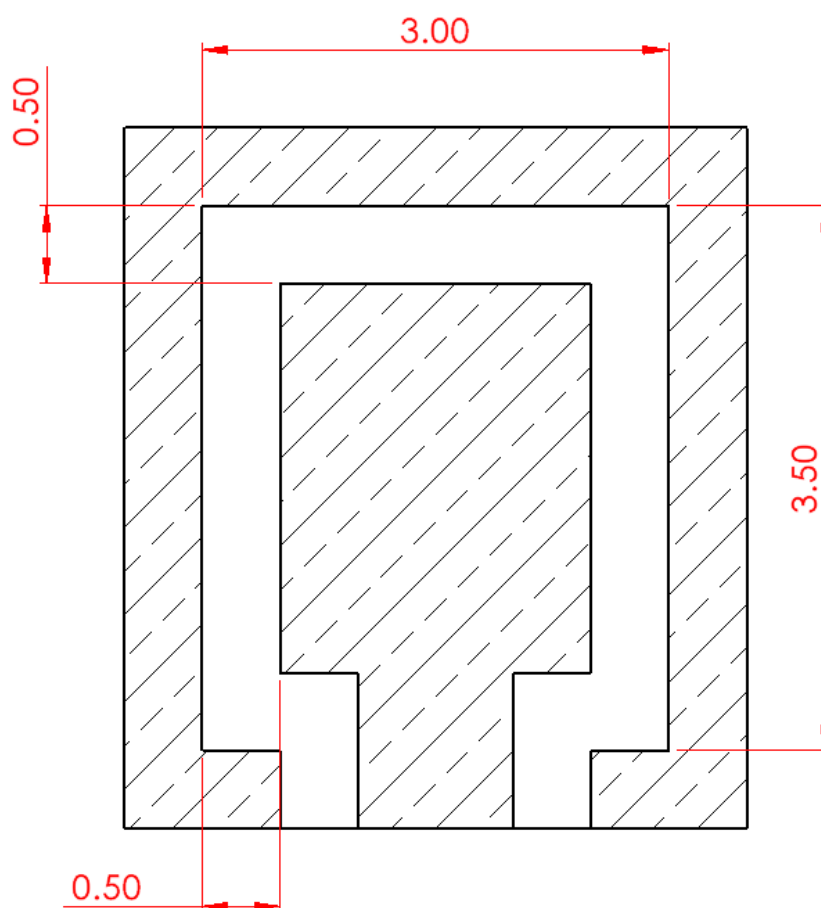
5.4 Top Solder Mask



5.5 Copper Clearance for SGGP254B

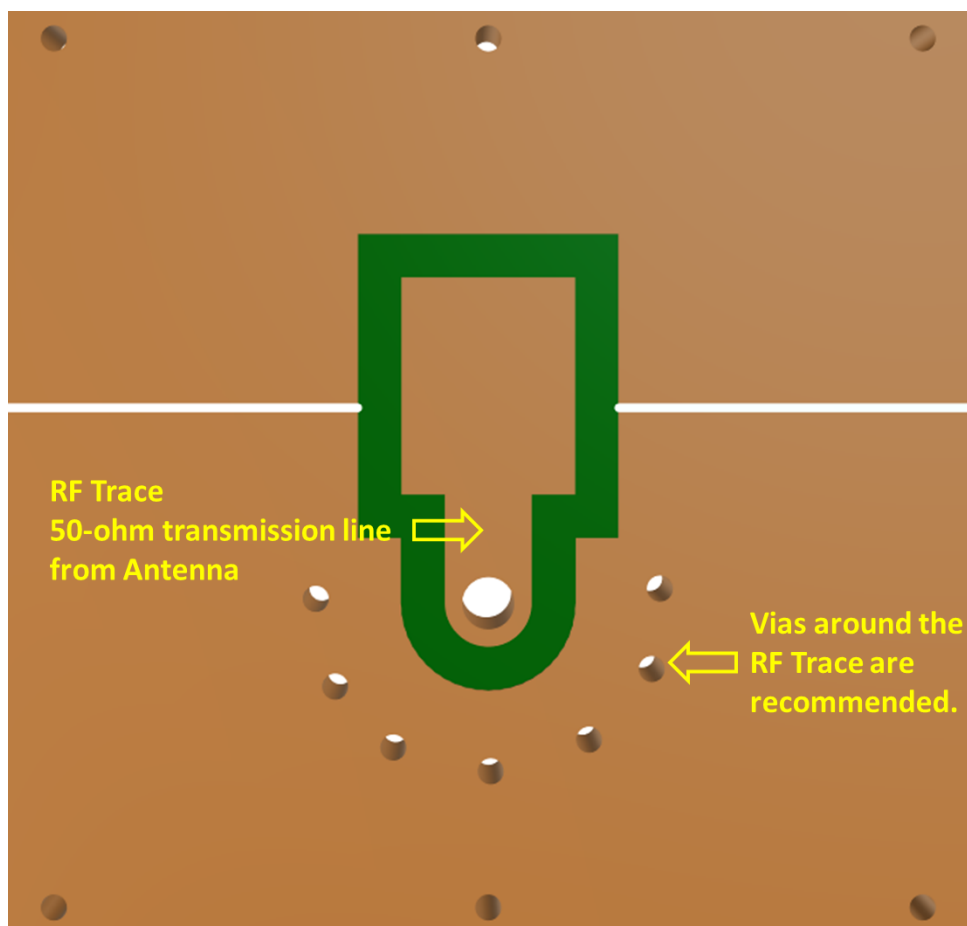
The footprint and clearance on the PCB must comply with the antenna's specification. The PCB layout shown in the diagrams below demonstrates the SGGP254B clearance area. The copper keep out area applies to the top layer and all internal layers.

There should be a 3.5x3mm copper clearance area around RF Feed pad.



5.6 Antenna Integration

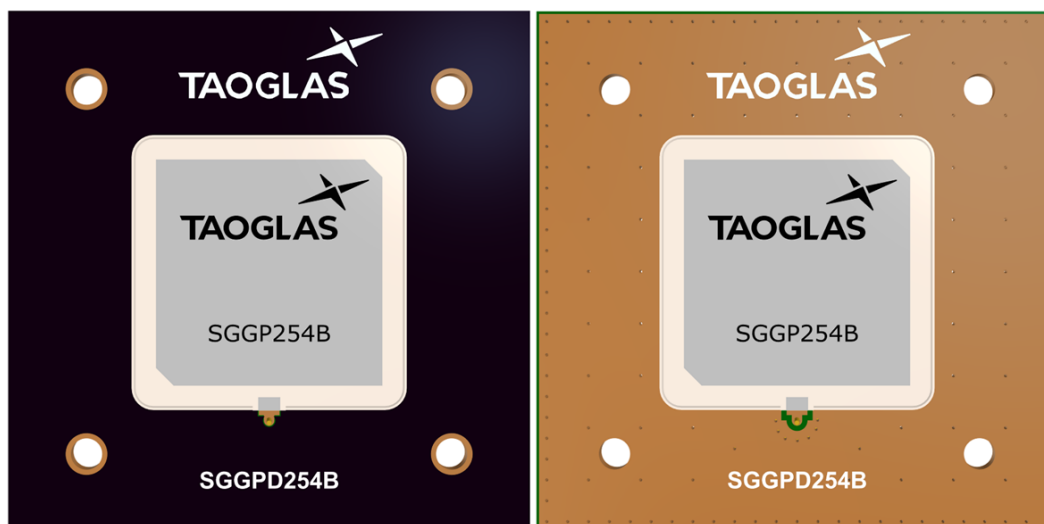
The SGGP254B should be placed in the centre, as close to the edge on the long side of the PCB as possible, to take advantage of the ground plane. The RF trace must maintain a 50 Ohm transmission line. Ground vias should be placed around the RF trace.



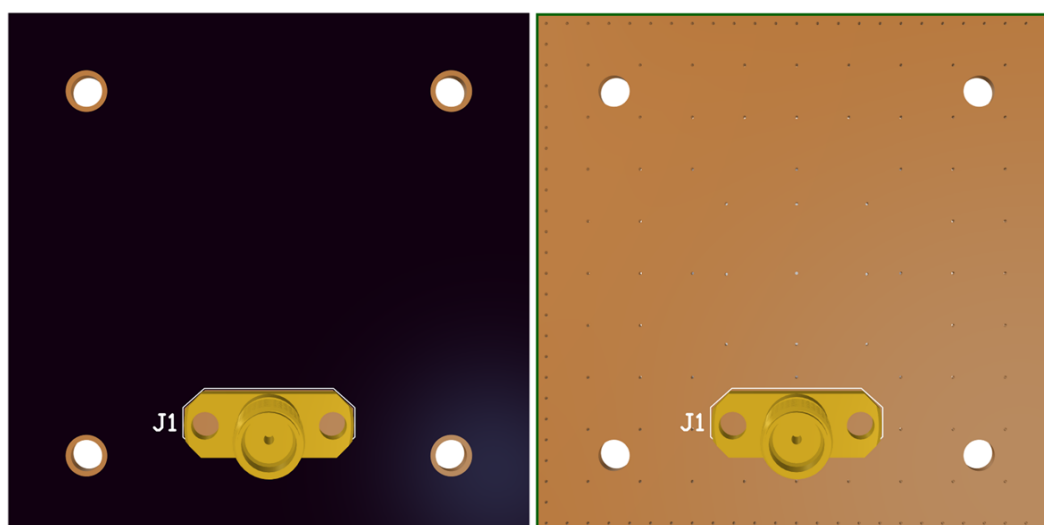
SGGP254B antenna mounted on a PCB reference design, showing transmission lines and integration notes.

5.7 Final Integration

The top side image shown below highlights the antenna transmission line. Taoglas recommends using a minimum of 50x50mm ground plane (PCB) to ensure optimal performance.



Top Side (SGGP254B placement on 50x50mm PCB reference design)



Bottom Side

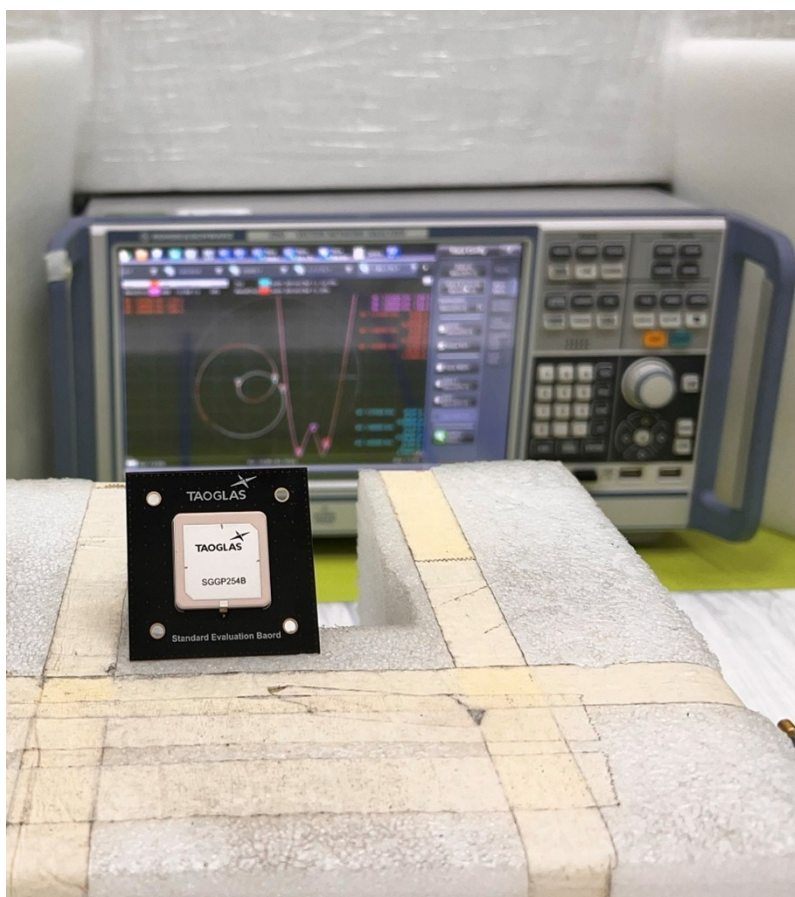
6. Antenna Characteristics

6.1 Test Setup

AUT

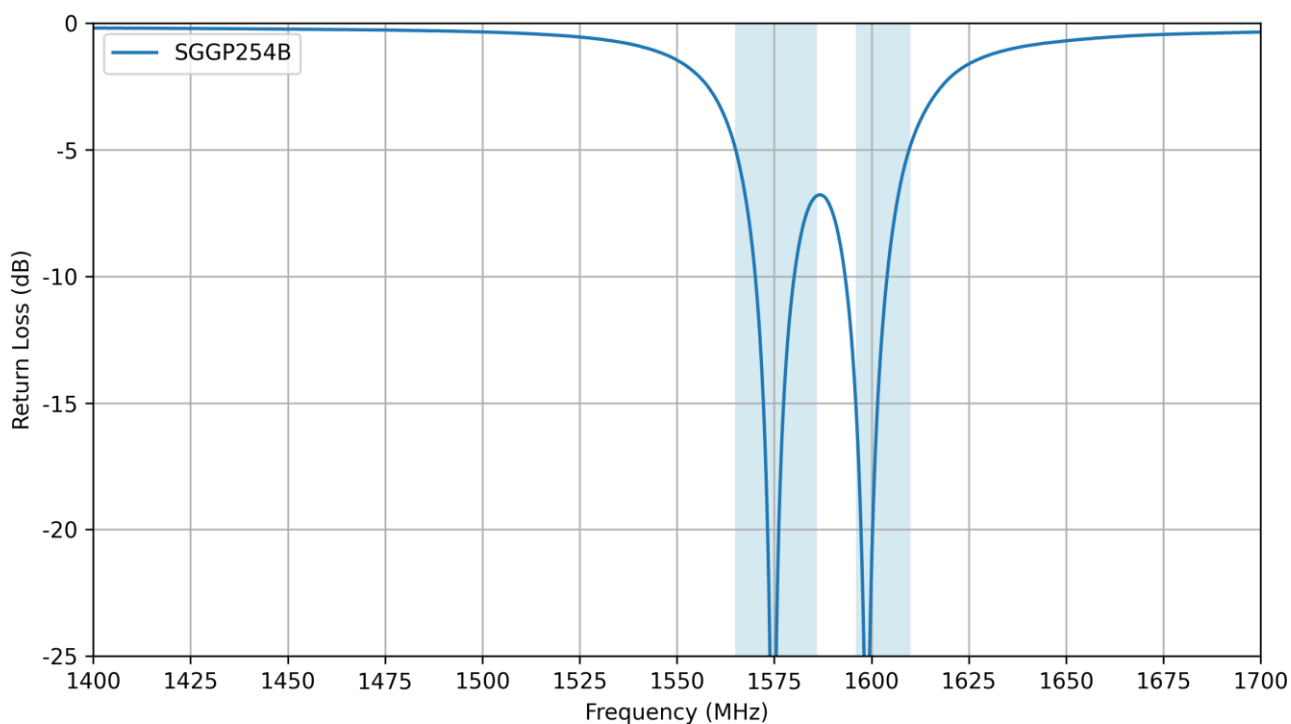


Vector Network Analyzer

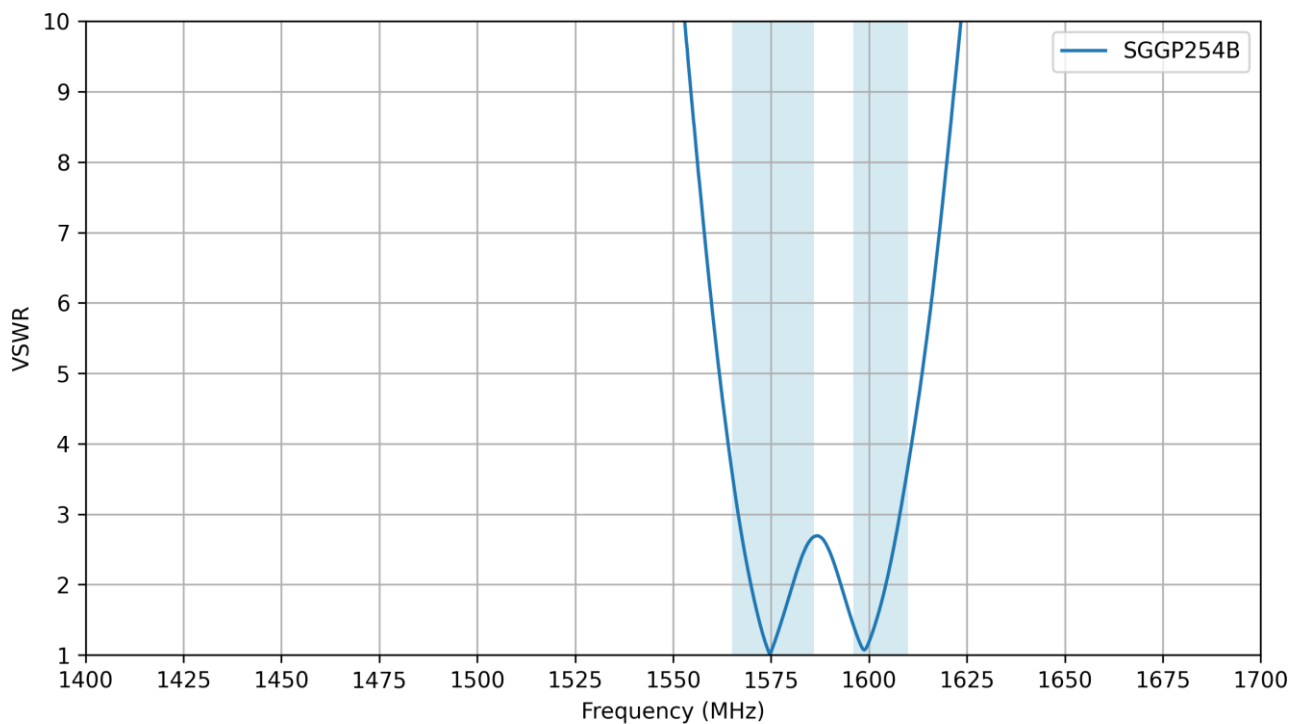


VNA Test Set-up

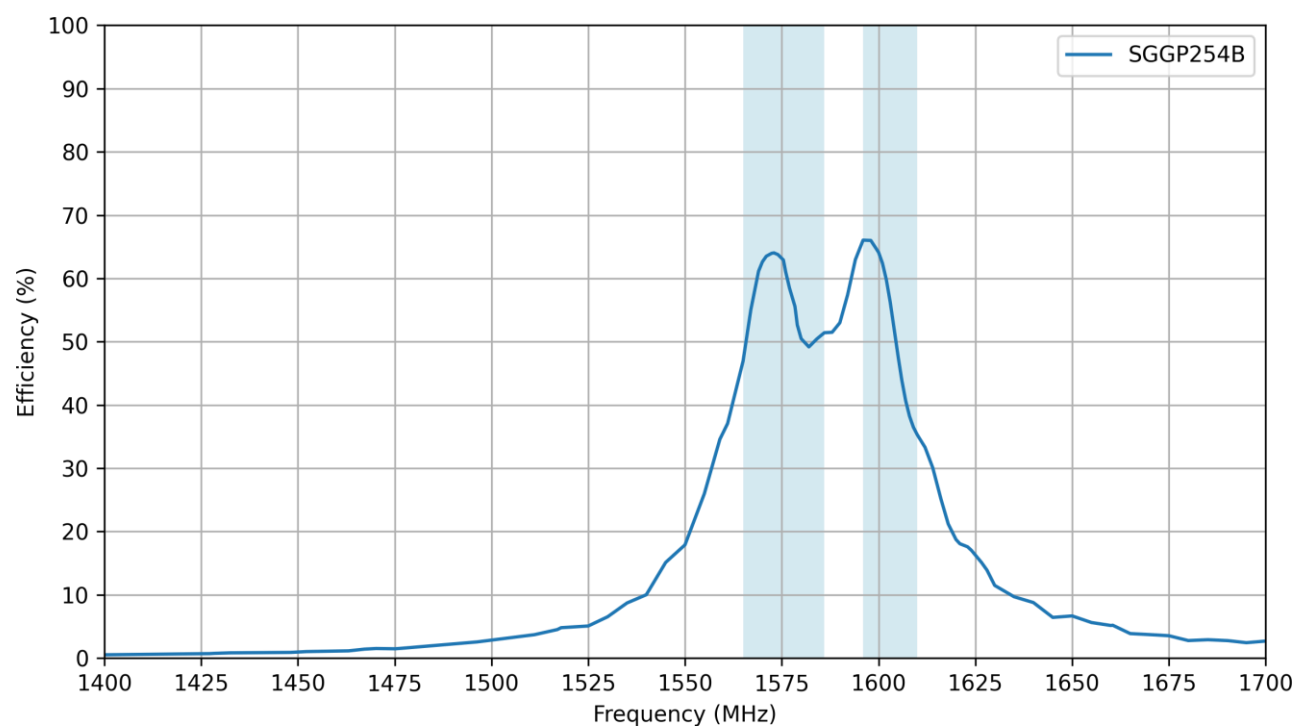
6.2 Return Loss



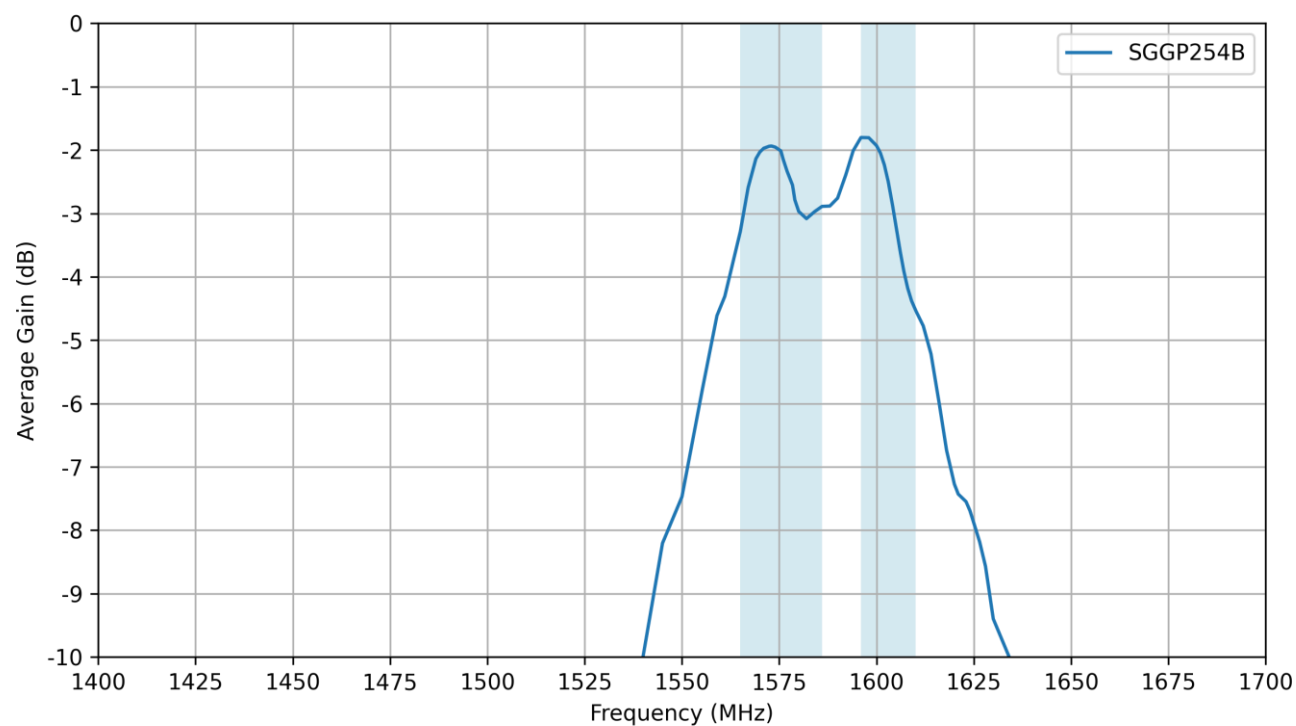
6.3 VSWR



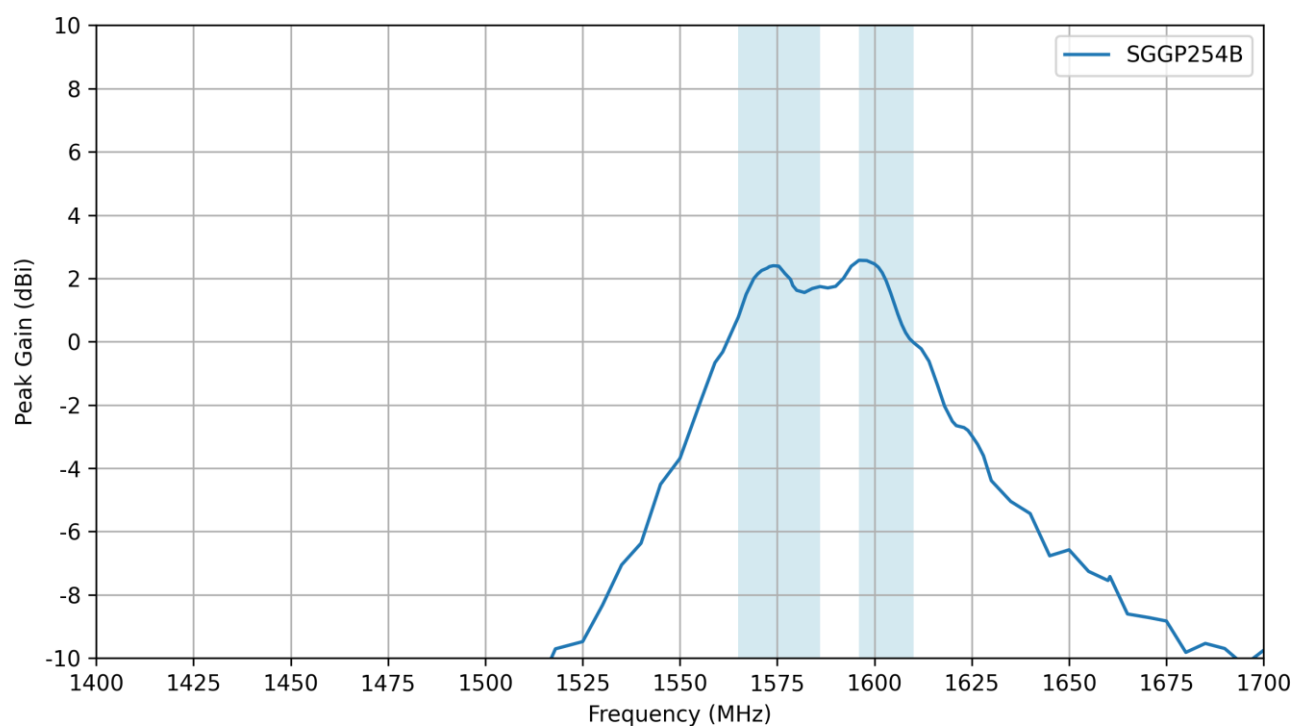
6.4 Efficiency



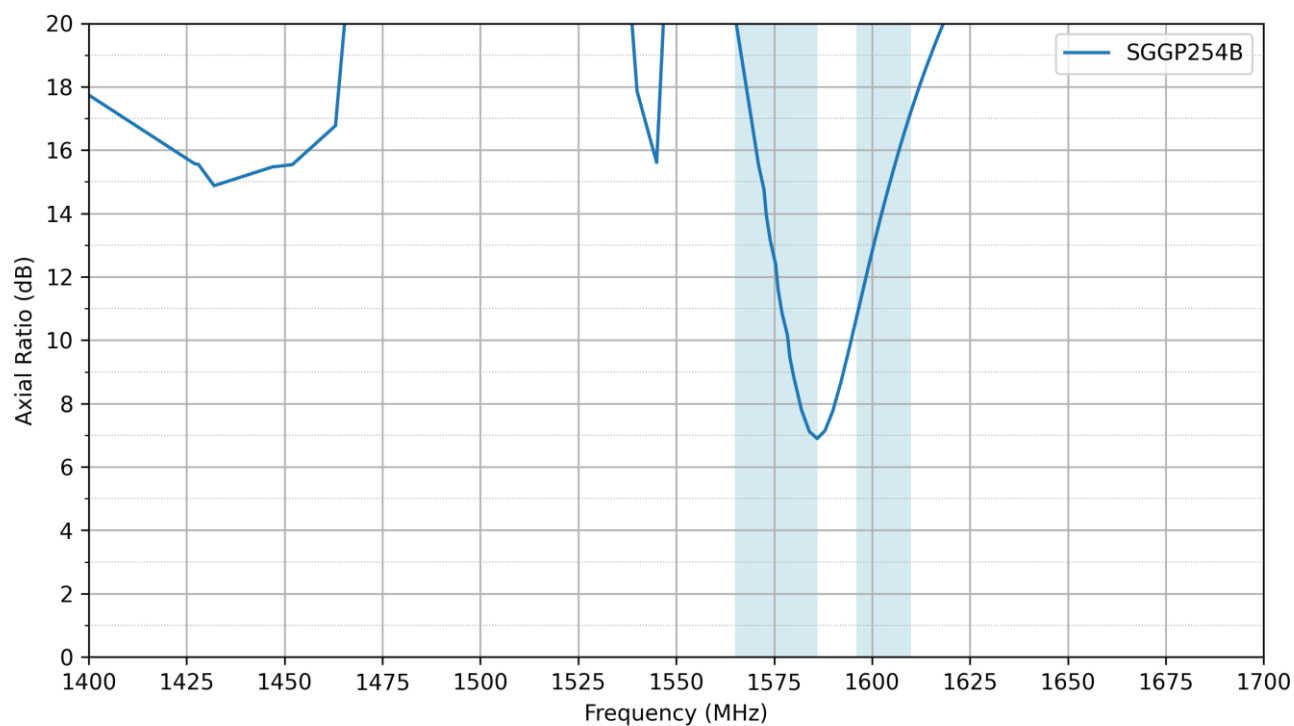
6.5 Average Gain



6.6 Peak Gain

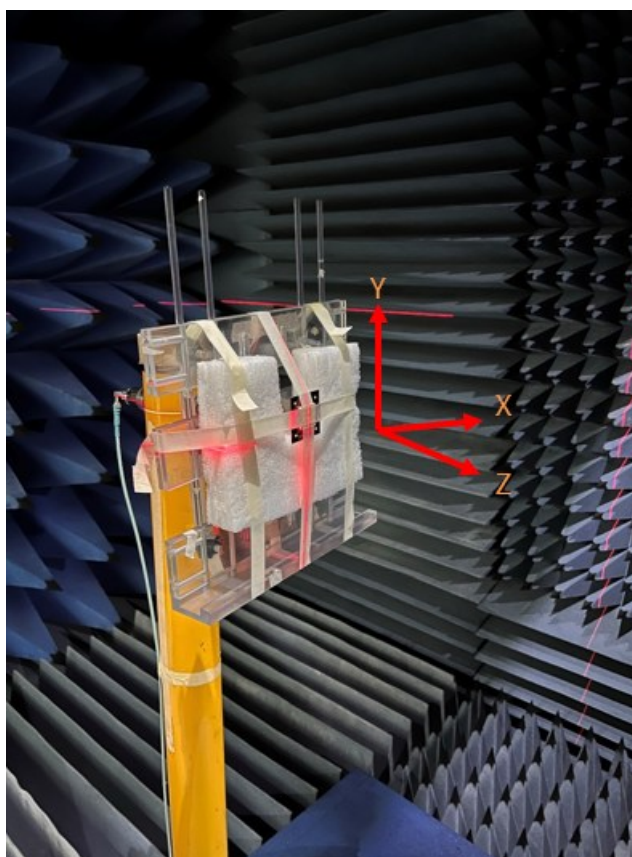


6.7 Axial Ratio



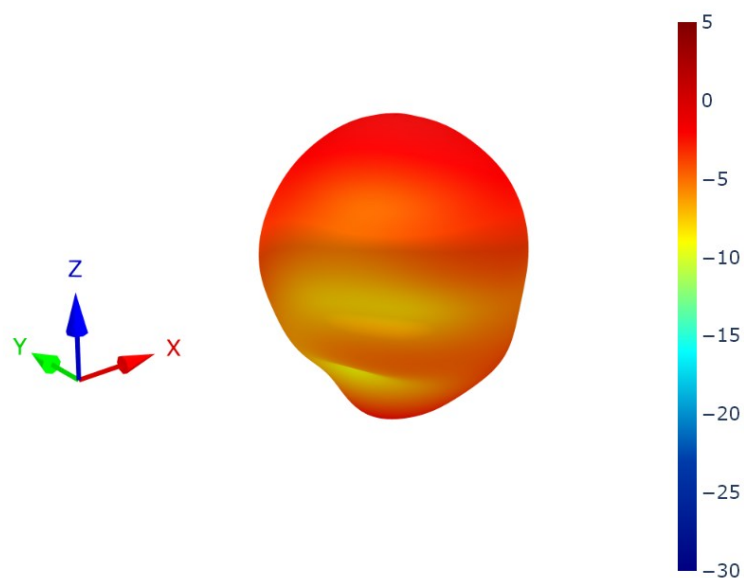
7. Radiation Patterns

7.1 Test Setup

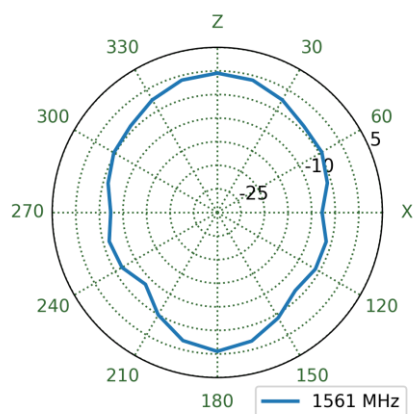


Chamber Test Set-up

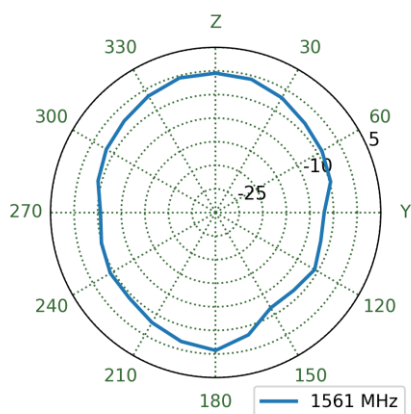
7.2 Patterns at 1561 MHz



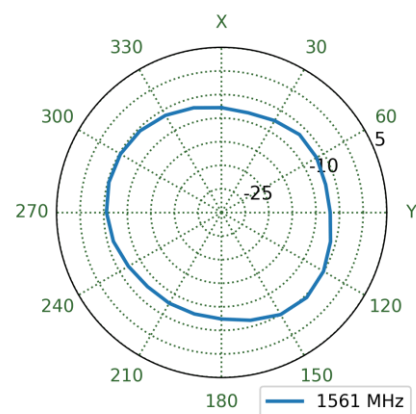
XZ Plane



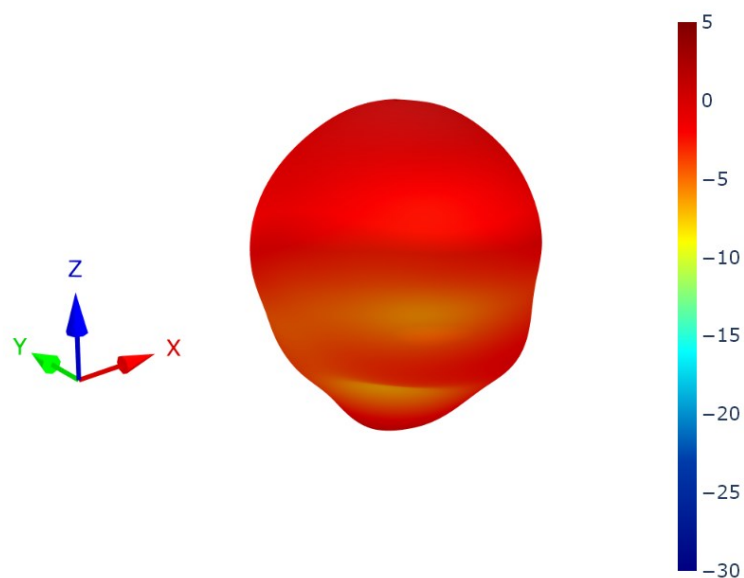
YZ Plane



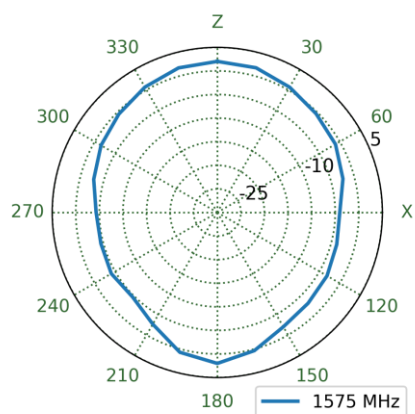
XY Plane



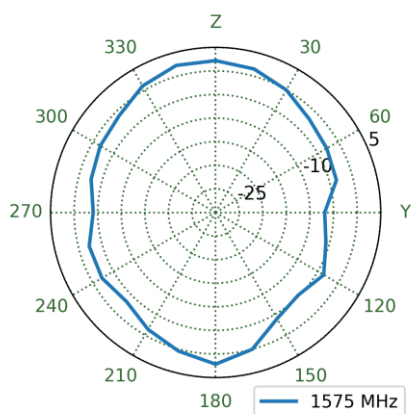
7.3 Patterns at 1575 MHz



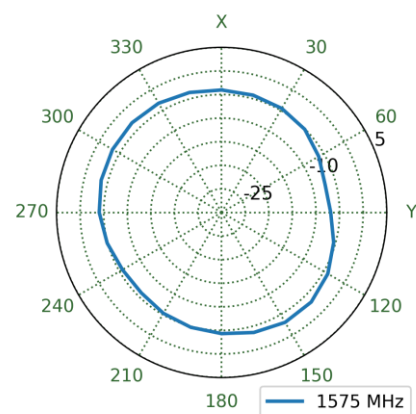
XZ Plane



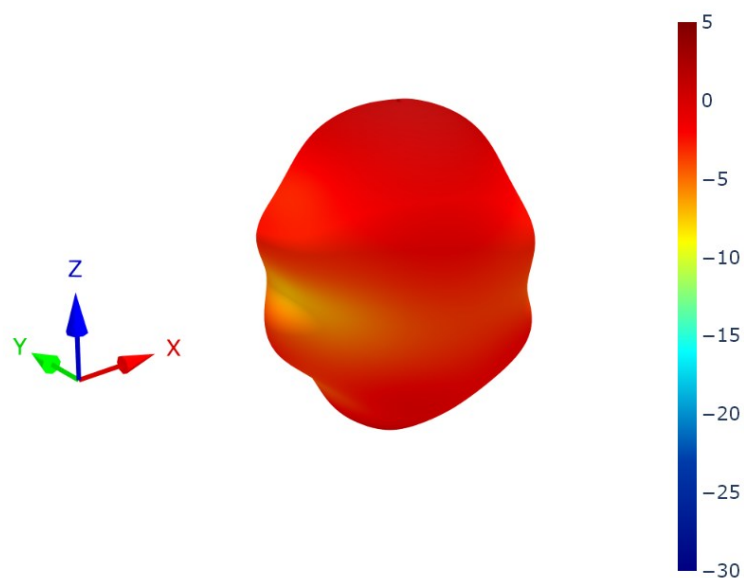
YZ Plane



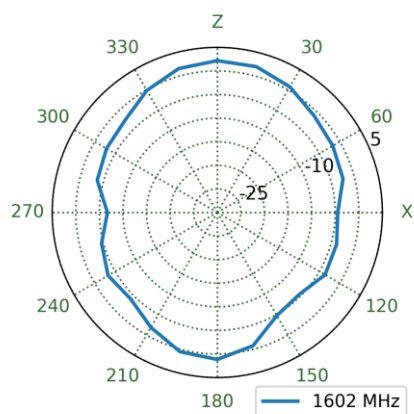
XY Plane



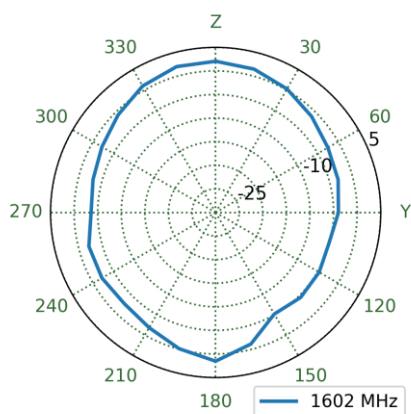
7.4 Patterns at 1602 MHz



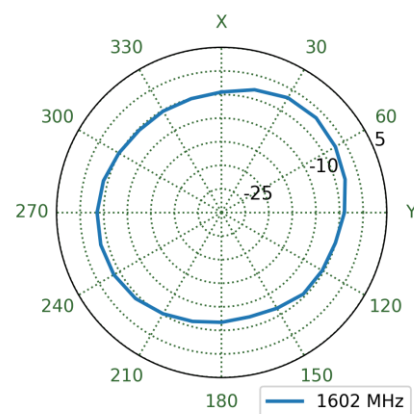
XZ Plane



YZ Plane

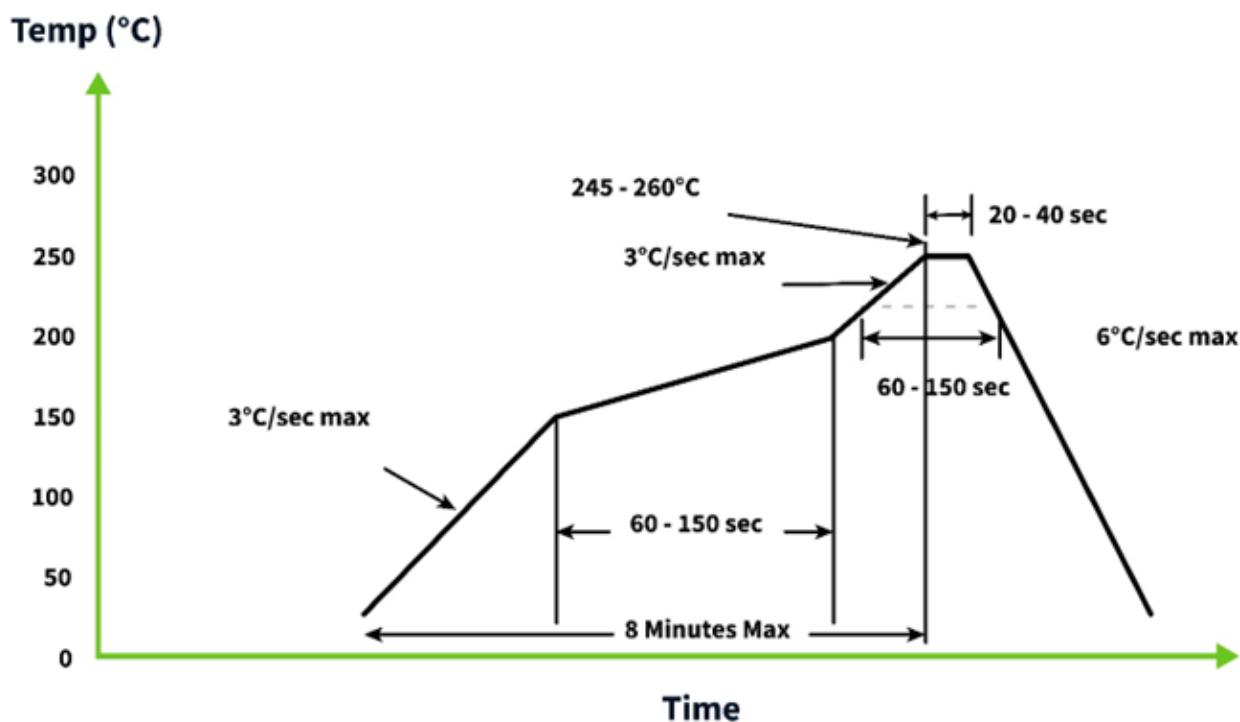


XY Plane



8. Solder Reflow Profile

The SGGP254B can be assembled by following the recommended soldering temperatures are as follows:



*Temperatures listed within a tolerance of $\pm 10^{\circ}\text{C}$

Smaller components are typically mounted on the first pass, however, we do advise mounting the SGGP254B when placing larger components on the board during subsequent reflows.

Note: Soldering flux classified ROL0 under IPC J-STD-004 is recommended

Changelog for the datasheet

SPE-25-8-117 – SGGP254B

Revision: A (Original First Release)	
Date:	2025-04-09
Notes:	Initial Release
Author:	Gary West



www.taoglas.com

